

# 4V Drive Nch+Nch MOSFET

## MP6K61

●Structure

Silicon N-channel MOSFET

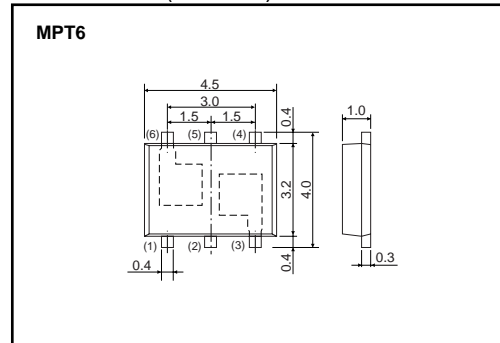
●Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.

●Application

Switching

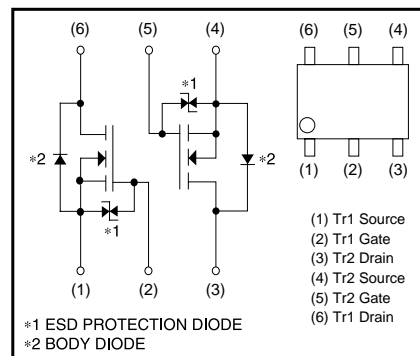
●Dimensions (Unit : mm)



●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	1000
MP6K61		○

●Equivalent circuit



\*1 A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter	Symbol	Limits	Unit
Drain-source voltage	V <sub>DSS</sub>	30	V
Gate-source voltage	V <sub>GSS</sub>	±20	V
Drain current	Continuous	I <sub>D</sub>	±5.0 A
	Pulsed	I <sub>DP</sub> *1	±20 A
Source current (Body diode)	Continuous	I <sub>S</sub>	1.6 A
	Pulsed	I <sub>SP</sub> *1	20 A
Total power dissipation	P <sub>D</sub> *2	2.0	W/TOTAL
		1.4	W/ELEMENT
Channel temperature	T <sub>ch</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

\*1 P<sub>w</sub> ≤ 10μs, Duty cycle ≤ 1%  
 \*2 MOUNTED ON A CERAMIC BOARD.

## Transistors

## ●Electrical characteristics (Ta=25°C)

&lt;It is the same characteristics for the Tr1 and Tr2.&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I <sub>gss</sub>	–	–	±10	μA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	30	–	–	V	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	–	–	1	μA	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS(th)</sub>	1.0	–	2.5	V	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state resistance	R <sub>DS(on)</sub> *	–	36	51	mΩ	I <sub>D</sub> =5.0A, V <sub>GS</sub> =10V
		–	50	70		I <sub>D</sub> =5.0A, V <sub>GS</sub> =4.5V
		–	55	77		I <sub>D</sub> =5.0A, V <sub>GS</sub> =4.0V
Forward transfer admittance	Y <sub>fs</sub>  *	3.0	–	–	S	I <sub>D</sub> =5.0A, V <sub>DS</sub> =10V
Input capacitance	C <sub>iss</sub>	–	460	–	pF	V <sub>DS</sub> =10V
Output capacitance	C <sub>oss</sub>	–	80	–	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	–	60	–	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	–	10	–	ns	I <sub>D</sub> =2.5A, V <sub>DD</sub> ≐15V
Rise time	t <sub>r</sub> *	–	20	–	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d(off)</sub> *	–	25	–	ns	R <sub>L</sub> =6.0Ω
Fall time	t <sub>f</sub> *	–	5	–	ns	R <sub>G</sub> =10Ω
Total gate charge	Q <sub>g</sub> *	–	4.0	–	nC	I <sub>D</sub> =5.0A, V <sub>DD</sub> ≐15V
Gate-source charge	Q <sub>gs</sub> *	–	1.8	–	nC	V <sub>GS</sub> =5V
Gate-drain charge	Q <sub>gd</sub> *	–	1.5	–	nC	R <sub>L</sub> =3.0Ω, R <sub>G</sub> =10Ω

\*Pulsed

## ●Body diode characteristics (Source-Drain) (Ta=25°C)

&lt;It is the same characteristics for the Tr1 and Tr2.&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V <sub>SD</sub> *	–	–	1.2	V	I <sub>S</sub> =5.0A, V <sub>GS</sub> =0V

\*Pulsed

Transistors

●Electrical characteristic curves

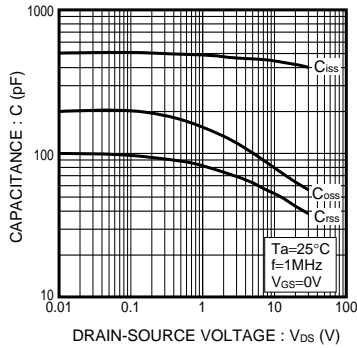


Fig.1 Typical Capacitance vs. Drain-Source Voltage

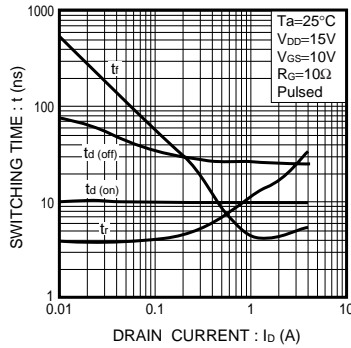


Fig.2 Switching Characteristics

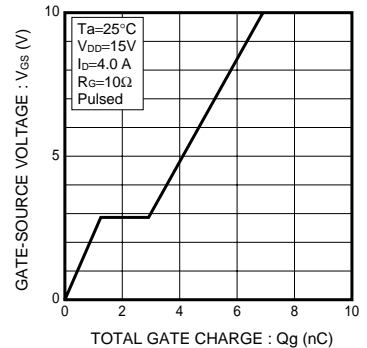


Fig.3 Dynamic Input Characteristics

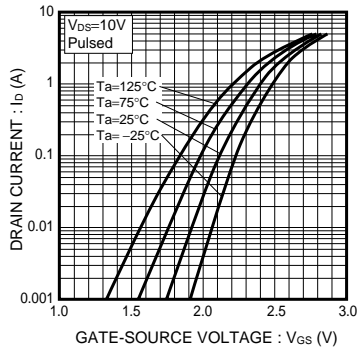


Fig.4 Typical Transfer Characteristics

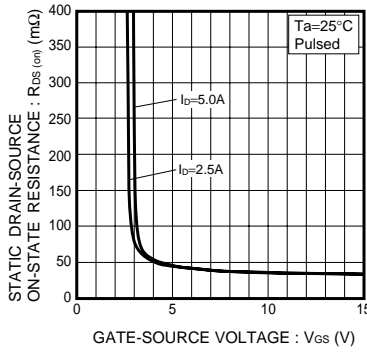


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

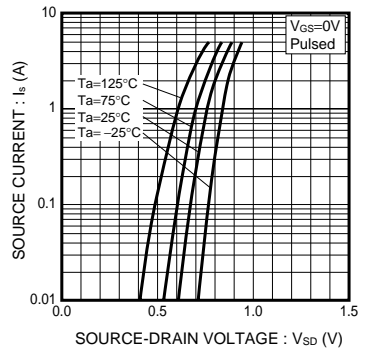


Fig.6 Source Current vs. Source-Drain Voltage

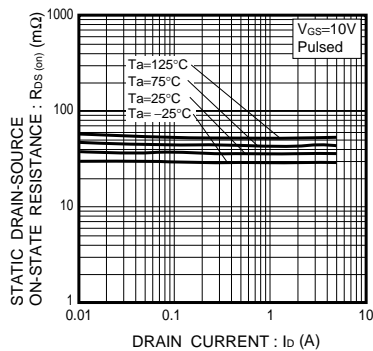


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

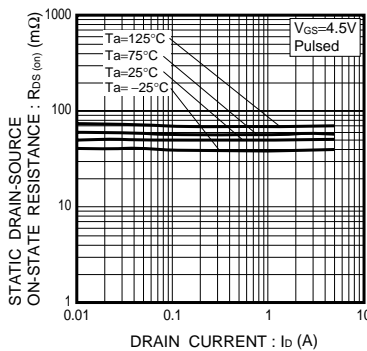


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

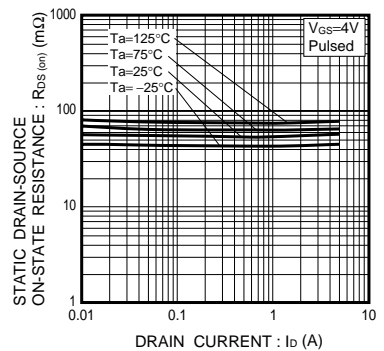


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

Transistors

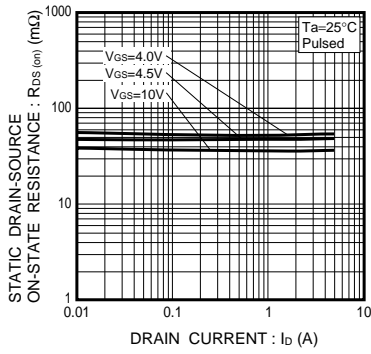


Fig.10 Static Drain-Source On-State Resistance vs. Drain Current (IV)

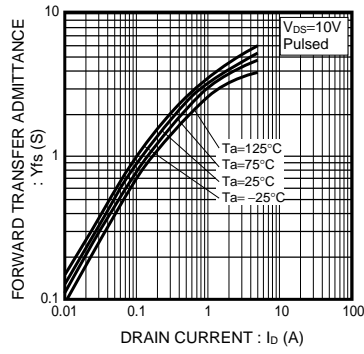


Fig.11 Forward Transfer Admittance vs. Drain Current

●Electrical characteristic curves

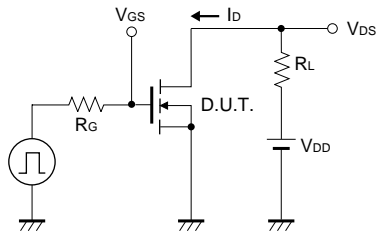


Fig.12 Switching Time Test Circuit

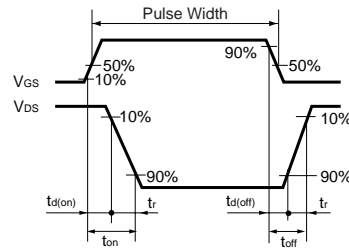


Fig.13 Switching Time Waveforms

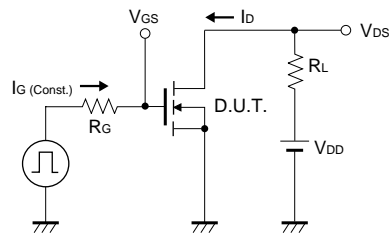


Fig.14 Gate Charge Test Circuit

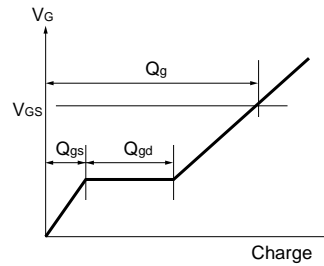


Fig.15 Gate Charge Waveform

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